

ETR25008-004

# One Cell Li-ion/Li-polymer Linear Charger IC with Battery Temperature Detection

## **■**GENERAL DESCRIPTION

The XC6804 is a Constant-Voltage (CV) and Constant-Current (CC) type charging IC for linear charging of single-cell Li-ion batteries and Li-polymer batteries. The basic charging cycle consists of trickle charge mode followed by main charge mode. This IC supports temperature control based on JEITA, making it possible to safely charge Li-ion batteries and Li-polymer batteries by controlling the CV charge voltage and CC charge current according to the temperature. By connecting a resistor to the charge status output pin, it is possible to check the charge condition via the charge status output (CSO) pin voltage. The IC is housed in the small SOP-8FD or USP-6EL package with high heat dissipation, and a charge circuit can be configured using a minimum of external components.

## **■**APPLICATIONS

- •Health care devices
- Power banks
- Portable audio players
- Bluetooth headsets
- Portable navigation devices
- Digital still cameras

## **■**FEATURES

JEITA conforming Thermistor Detect Function Built-in

Operating Voltage Range :  $4.5V \sim 6V$ Supply Current : TYP.  $100\mu A$ 

CC Charge Current : 200mA ~ 800mA Can be set by external resistance
CV Charge Voltage : 4.2V, 4.05V (at high temperature) Internally fixed

Protection Circuit : Thermistor detection function

Safety timer function

UVLO (Under Voltage Lockout)

Thermal shutdown (Auto recovery)

Dropout voltage monitor function

Charging over-voltage monitor function

Charging over-current monitor function

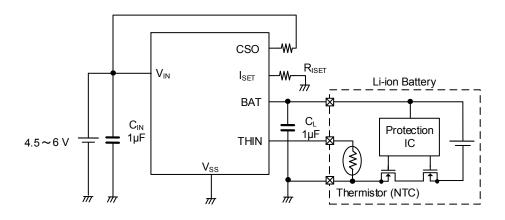
Recharge function (XC6804xxE)

Operating Ambient Temperature : -40°C ~ +85°C

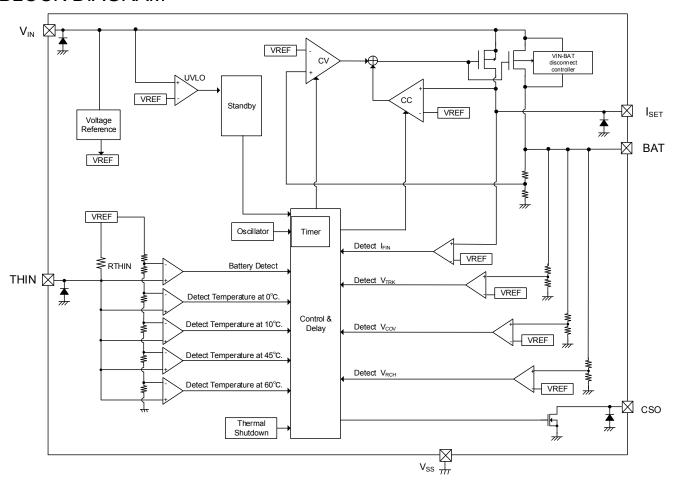
Packages : SOP-8FD, USP-6EL

Environmentally Friendly : EU RoHS Compliant, Pb Free

## ■TYPICAL APPLICATION CIRCUIT



# **■BLOCK DIAGRAM**



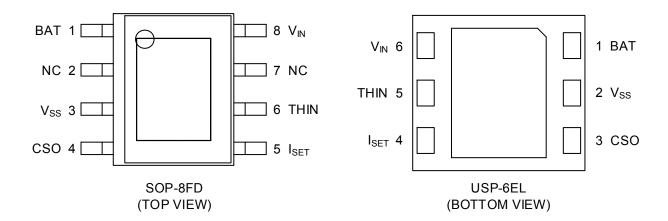
## ■ PRODUCT CLASSIFICATION

XC6804123456-7 (\*1)

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
(I)	Charge Status Output on Abnormal Made	Α	1 kHz ON-OFF
1	Charge Status Output on Abnormal Mode	В	OFF
		2	2 Temperature Monitor
2	Battery Temperature Monitor Function	3	3 Temperature Monitor
		4	4 Temperature Monitor
	Pochargo Function	E	Enable
3	Recharge Function	D	Disable
4	CV Charge Voltage	1	4.2 V (Fixed)
\$6-7	Packages (Order Unit)	QR-G	SOP-8FD (1,000pcs/Reel)
	Fackages (Older Utilit)	4R-G	USP-6EL (3,000pcs/Reel)

<sup>(\*1)</sup> The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

## **■PIN CONFIGURATION**



<sup>\*</sup>To increase mounting strength and heat dissipation of the USP-6EL, it is recommended that the heat sink be mounted by soldering using the reference pattern layout and reference metal mask. To use the electric potential of the heat sink, connect to the V<sub>SS</sub> pin (Pin # 2).

# ■ PIN ASSIGNMENT

PIN NUMBER		PIN NAME	FUNCTIONS	
SOP-8FD	USP-6EL	PIN NAME	FUNCTIONS	
1	1	BAT	Charge Current Output	
3	2	V <sub>SS</sub>	Ground	
4	3	CSO	Charge Status Output	
5	4	I <sub>SET</sub>	Charge Current Setup	
6	5	THIN	Temperature Detection	
8	6	$V_{IN}$	Power Supply Input	
-	Back Metal	-	Internally Connected V <sub>SS</sub>	
2, 7	-	NC	Non connect Pin	

<sup>\*</sup>To increase mounting strength and heat dissipation of the SOP-8FD, it is recommended that the heat sink be mounted by soldering using the reference pattern layout and reference metal mask. To use the electric potential of the heat sink, connect to the V<sub>SS</sub> pin (Pin # 3).

# ■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER		SYMBOL	RATING	UNIT
V <sub>IN</sub> Pin Voltage		V <sub>IN</sub>	-0.3 ~ +6.5	V
BAT Pin Voltage		$V_{BAT}$	-0.3 ~ +6.5	V
CSO P	in Voltage	V <sub>CSO</sub>	-0.3 ~ +6.5	V
THIN F	in Voltage	$V_{THIN}$	-0.3 ~ V <sub>IN</sub> +0.3 or +6.5 <sup>(*1)</sup>	V
I <sub>SET</sub> Pi	n Voltage	V <sub>ISET</sub>	-0.3 ~ V <sub>IN</sub> +0.3 or +6.5 <sup>(*1)</sup>	V
BAT P	in Current	I <sub>BAT</sub>	1600	mA
	000.050	SOP-8FD Pd 300 1500 (PCB mounted)	300	
Dawan Diasinatian	20P-8FD			
Power Dissipation	LICD CEL	D4	120	mW
	USP-6EL	Pd	750 (PCB mounted)	
Operating Amb	pient Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature		T <sub>stg</sub>	-55 ~ +125	°C

Each rating voltage is based on the Vss.

 $<sup>^{(\</sup>mbox{\tiny $^{1}$})}$  Either of lower one,  $V_{\mbox{\tiny $1N$}}\mbox{+}0.3$  or +6.5, is applicable.

# ■ ELECTRICAL CHARACTERISTICS

Unless otherwise stated, V $_{\text{IN}}$  =5.0V, V $_{\text{THIN}}$  =1.0V, C $_{\text{IN}}$  =C $_{\text{L}}$  =1 $\mu\text{F},$  Ta=25 $^{\circ}\text{C}$ 

PARAMETER	SYMBO L	CONDITION	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Operating Voltage Range	V <sub>IN</sub>		4.5	5	6	V	-
Supply Current (*1)	I <sub>ss</sub>	V <sub>BAT</sub> = 3.5 V	-	110	-	μA	1
Standby Current	I <sub>STB</sub>	$V_{BAT} = 4.3 \text{ V},$ $I_{STB} = I_{IN} - I_{THIN}$	-	60	-	μA	1
V <sub>IN</sub> -V <sub>BAT</sub> Shut-down Voltage	$V_{IBSD}$	V <sub>BAT</sub> = 4.1 V	-	40	-	mV	2
Shut-down Hysteresis Voltage (*1)	V <sub>IBSDHYS</sub>		ı	60	-	mV	2
UVLO Voltage	$V_{\text{UVLO}}$		3.6	3.8	4	V	2
UVLO Hysteresis Voltage (*1)	V <sub>UVLOHYS</sub>		-	200	-	mV	2
Trickle Charge Voltage	$V_{TRK}$		2.8	2.9	3	٧	2
Trickle Charge Hysteresis Voltage (*1)	V <sub>TRKHYS</sub>		-	100	-	mV	2
Trickle Charge Current (Min.) (*1)	I <sub>TRKI</sub>	$R_{ISET} = 41.2 \text{ k}\Omega, V_{BAT} = 2.4 \text{ V}$	-	21	-	mA	2
Trickle Charge Current	I <sub>TRK</sub>	$R_{ISET}$ = 20 k $\Omega$ , $V_{BAT}$ = 2.4 V	28.5	41	50	mA	2
Trickle Charge Current (Max.) (*1)	I <sub>TRKA</sub>	$R_{ISET} = 8.87 \text{ k}\Omega, V_{BAT} = 2.4 \text{ V}$	1	85	-	mA	2
CV Charge Voltage	$V_{BAC}$	I <sub>BAT</sub> = 60 mA	4.17	4.2	4.23	V	3
CV Charge Voltage	V BAC	$V_{THIN} = V_{THIN\_open} \times V_{T45}^{(*2)}$	4.02	4.05	4.08	V	3
		$R_{ISET}$ = 41.2 k $\Omega$ , $V_{BAT}$ = 3.1 V	i	200	-	mA	2
CC Charge Current (Min.) (*1)	I <sub>BACI</sub>	$R_{ISET} = 41.2 \text{ k}\Omega, V_{BAT} = 3.1 \text{ V}$ $V_{THIN} = V_{THIN\_open} \times V_{T10} (*3)$	-	92	-	mA	2
		$R_{ISET}$ = 20 k $\Omega$ , $V_{BAT}$ = 3.1 V	325	382	438	mA	2
CC Charge Current	I <sub>BAC</sub>	$R_{ISET} = 20 \text{ k}\Omega, V_{BAT} = 3.1 \text{ V}$ $V_{THIN} = V_{THIN\_open} \times V_{T10}$ (*3)	152	176	203	mA	2
		$R_{ISET}$ = 8.87 k $\Omega$ , $V_{BAT}$ = 3.1 V	-	800	-	mA	2
CC Charge Current (Max.) (*1)	I <sub>BACA</sub>	$R_{ISET} = 8.87 \text{ k}\Omega, V_{BAT} = 3.1 \text{ V}$ $V_{THIN} = V_{THIN\_open} \times V_{T10}$ (*3)	-	368	-	mA	2
Charge Completion Current (Min) (*1)	I <sub>FINI</sub>	$R_{ISET}$ = 41.2 k $\Omega$	-	20	-	mA	3
Charge Completion Current	I <sub>FIN</sub>	R <sub>ISET</sub> = 20 kΩ	32	47	62	mA	3
Charge Completion Current (Max) (*1)	I <sub>FINA</sub>	R <sub>ISET</sub> = 8.87 kΩ	-	98	-	mA	3
Over Voltage Protection Threshold	$V_{\text{COV}}$		4.3	4.45	4.6	٧	2
Over Current Protection Threshold (*1)	I <sub>COP</sub>	R <sub>ISET</sub> = 2.8 kΩ	-	1200	-	mA	2
Driver ON Resistance	R <sub>on</sub>	V <sub>IN</sub> = 4.1 V, I <sub>BAT</sub> = 200 mA	-	350	550	mΩ	3
Driver Leakage Current	I <sub>LEAK</sub>	V <sub>IN</sub> = 6.0 V, V <sub>BAT</sub> = 0 V	-	-	1	μA	⑤
BAT Pin Reverse Current	I <sub>REV</sub>	V <sub>IN</sub> = 0 V, V <sub>BAT</sub> = 4.5 V	2.0	4.5	9.0	μA	6
BAT Pin Pull-down Current	I <sub>BATPD</sub>	V <sub>IN</sub> = 5.0 V, V <sub>BAT</sub> = 4.3 V	1.5	3.0	7.0	μA	2
Decharge Voltage (VCCCCA)	.,		3.7	3.9	4.1	V	2
Recharge Voltage (XC6804xxE)	V <sub>RCHG</sub>	V <sub>THIN</sub> = V <sub>THIN_open</sub> x V <sub>T45</sub> (*2)	3.55	3.75	3.95	V	2

<sup>(\*1)</sup> Design target

 $<sup>^{(^{\</sup>circ}2)}$ Applicable only for the XC6804x4

 $<sup>\</sup>ensuremath{^{(^*3)}}\mbox{Applicable}$  only for the XC6804x3 and the XC6804x4

# ■ ELECTRICAL CHARACTERISTICS

Unless otherwise stated, V\_IN=5.0V, V\_THIN=1.0V, R\_ISET=41.2k $\Omega$ , C\_IN=C\_L=1 $\mu$ F, Ta=25°C

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	CIRCUIT
THIN Pin Open Voltage	V <sub>THIN_open</sub>		1.94	2.0	2.06	V	5
Battery Connect Detection	V <sub>TD</sub>		77	80	83	% (*2)	2
Battery Connect Detection Hysteresis (*1)	$V_{TDH}$	At temperature fall	-	3	-	% (*2)	2
Thermistor Detection at 0°C	V <sub>T0</sub>		71.13	73.13	75.13	% (*2)	2
Thermistor Detection Hysteresis at 0°C (*1)	$V_{T0H}$	At temperature rise	-	2.18	-	% (*2)	2
Thermistor Detection at 10°C (*3)	V <sub>T10</sub>		62.19	64.19	66.19	% (*2)	2
Thermistor Detection Hysteresis at 10°C (*1)	V <sub>T10H</sub>	At temperature rise	-	2.38	-	% (*2)	2
Thermistor Detection at 45°C	$V_{T45}$		30.96	32.96	34.96	% (*2)	2
Thermistor Detection Hysteresis at 45°C (*1)	$V_{T45H}$	At temperature fall	-	1.94	-	% (*2)	2
Thermistor Detection at 60°C (*4)	V <sub>T60</sub>		21.16	23.16	25.16	% (*2)	2
Thermistor Detection Hysteresis at 60°C (*1) (*4)	V <sub>T60H</sub>	At temperature fall	-	1.47	-	% (*2)	2
THIN Pin Connected Resistance	R <sub>THIN</sub>	V <sub>THIN</sub> = 0 V	9.8	10	10.2	kΩ	5
Trickle Charge Hold Time	t <sub>TRK</sub>		-	2	-	hr	2
Main Charge Hold Time	t <sub>CHG</sub>		-	10	-	hr	2
CSO Pin OFF Current	I <sub>CSOOFF</sub>	V <sub>CSO</sub> = 6.0 V	-	-	1	μA	7
CSO Pin ON Voltage	V <sub>cso</sub>	I <sub>CSO</sub> = 10 mA	-	-	0.5	V	4
Thermal Shut-Down Detection Temperature (*1)	T <sub>TSD</sub>		-	115	-	°C	2
Thermal Shut-Down Detection Temperature Hysteresis (*1)	$T_{TSDH}$		-	10	-	°C	2
CSO Frequency (XC6804A)	f <sub>CSO</sub>		0.75	1	1.25	kHz	2

<sup>(\*1)</sup> Design target

 $V_{Txx} = V_{Txx'} / V_{THIN\_open}$ 

 $(V_{Txx'}$ : Voltage when the external voltage applied to the THIN pin sweeps and the IC internal comparator inverts)

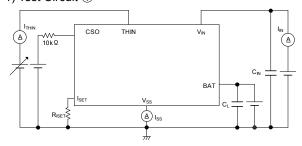
 $<sup>^{(^{\</sup>circ}2)}$  The comparator detect voltage and hysteresis width are indicated as percentages of the THIN pin open voltage,  $V_{\text{THIN\_open}}$ , (taken to be100%)

 $<sup>\</sup>ensuremath{^{(^*3)}}$  Applicable only for the XC6804x3 and the XC6804x4

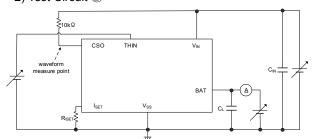
<sup>(\*4)</sup> Applicable only for the XC6804x4

# ■ TEST CIRCUITS

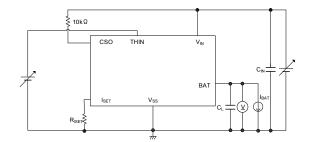
## 1) Test Circuit ①



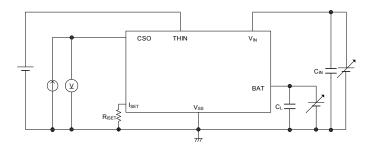
## 2) Test Circuit ②



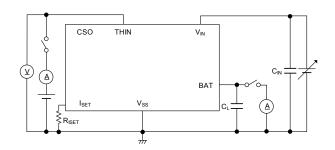
## 3) Test Circuit ③



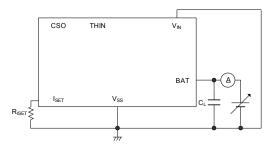
## 4) Test Circuit ④



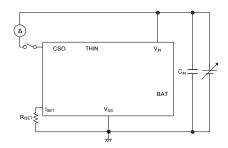
## 5) Test Circuit (5)



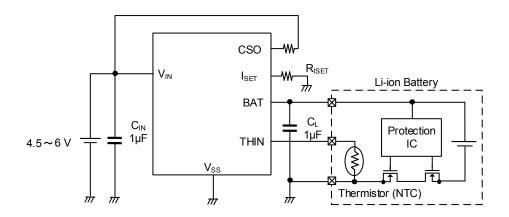
## 6) Test Circuit®



## 7) Test Circuit 7



# **■**TYPICAL APPLICATION CIRCUIT

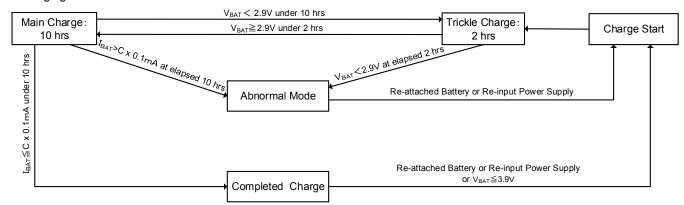


### [Recommended parts]

	MANUFACTURE	PRODUCT NUMBER	VALUE
Cin	TAIYO YUDEN	LMK107BJ105KA	1μF/10V
CL	TAIYO YUDEN	LMK107BJ105KA	1μF/10V
NTC	Murata	NCP15XH103F03RC	Resistance: 10kΩ @ 25°C B-constant (25 - 50°C): 3380K
RISET			8.87~ 41.2kΩ

### OPERATIONAL EXPLANATION

#### <Charging function>



#### Charging start

When a thermistor is connected to the THIN pin after a voltage is applied to the power input pin (1), or when a voltage is applied to the power input pin after a thermistor is connected to the THIN pin (2), the power on reset function activates and initializes the internal counter. After 200ms elapses in the case of 1, or 150ms in the case of 2, charging starts.

#### Trickle charging: Less than 2 hours

Trickle charging determines if main charging of the Li-ion battery is possible. The Li-ion battery is charged at a trickle charge current that is one-tenth the charge current set with the external resistor  $R_{ISET}$ . If the BAT pin voltage  $V_{BAT}$  is above 2.9V in the charging start state, trickle charging takes place for 1ms and then main charging begins. If  $V_{BAT}$  is less than 2.9V, trickle charging takes place, and main charging begins 50ms after 2.9V is detected. If the BAT pin voltage is less than 2.9V after 2 hours, the IC changes to the error state and stops charging the Li-ion battery. In addition, the error in the trickle charge current increases if  $V_{BAT}$  drops below about 1V.

#### Main charging: Less than 10 hours

When the condition for transition from trickle charging is satisfied, it is determined that rapid charging of the Li-ion battery is possible and the IC changes to the main charging state. In main charging, the IC charges a Li-ion battery at a CC charge current that is set with the external resistor R<sub>ISET</sub>. When the BAT pin voltage rises to the CV charge voltage in less than 10 hours and the charge current drops to the charging completed current, and after 50ms elapses,the IC changes to the charging completed state and charging stops. If the charge current is higher than the charging completed current after 10 hours, the IC changes to the error state and stops charging.

#### Charging completed

When the charge current reaches the charge completion current, which is one-tenth the charge current set with the external resistor  $R_{\text{ISET}}$ , and after 50 ms elapses, the IC changes to charging completed and stops charging the Li-ion battery. At this time, the charge status output pin changes from ON to OFF. On the XC6804xxE, when the BAT pin voltage ( $V_{\text{BAT}}$ ) falls from the charge completion state to the recharge voltage ( $V_{\text{RCHG}}$ ) or less, charging automatically restarts. When a voltage is reapplied to the power input pin or a Li-ion battery is reconnected to the BAT pin in the charging completed state, the IC starts and charging begins.

#### Error state

If it is determined that charging is abnormal in any state, the IC treats this as an error state and stops charging. When the power is turned off and then on, or the battery is reinserted, the IC starts up gain and starts charging. An error state occurs if 2 hours elapses during trickle charging, if 10 hours elapses during main charging, or if charging overvoltage or charging overcurrent is detected.

#### Charging status output pin, CSO

The charge status output pin turns ON by Nch open drain output during trickle charging and main charging, and turns OFF after charging is completed. An LED can be connected to enable confirmation of charging by illumination of the LED. If an abnormal condition is detected, the charge status output pin repeats ON-OFF at 1kHz on the XC6804A, and turns off on the XC6804B. An error state indicates a state in which 2 hours have elapsed during trickle charging, 10 hours have elapsed during main charging, or charging over-voltage or charging over-current is detected.

#### Charge current

The charge current  $I_{CHG}$  of this IC can be set in the range 200mA to 800mA by means of the external resistance  $R_{ISET}$ . The relation between  $R_{ISET}$  and  $I_{CHG}$  is approximated by the equation below.

RISET 
$$(k\Omega) = 15950 \text{ x I}_{CHG}^{-1.122} \text{ (mA)}$$

(\*1) The XC6804xxD does not have the recharge function.

## OPERATIONAL EXPLANATION (Continued)

#### IC temperature monitoring function

In order to prevent destruction due to IC heat generation as well as abnormal charging due to thermal runaway, a thermal shutdown circuit is incorporated into the IC. If the chip temperature rises to  $115^{\circ}$ C or higher and after 50ms elapses, this function turns off the output driver and stops charging. When 50ms elapse with the chip temperature  $105^{\circ}$ C or less, this function returns the IC to the main charging state and starts charging. Even when charging is stopped by this function, the  $t_{TRK}$  and  $t_{CHG}$  counts are continued.

#### Dropout voltage monitoring function

To prevent reverse current from the Li-ion battery to the battery charger, this function monitors the dropout voltage between the BAT pin voltage ( $V_{IRAT}$ ) and power input pin voltage ( $V_{IN}$ ). When the  $V_{IN}$  falls to  $V_{BAT}$  + 40mV, the function turns off the output driver and switches the backgating connection from the power pin to the BAT pin. When  $V_{IN}$  rises higher than  $V_{BAT}$  + 0.1V, this function is released, the output driver turns ON, the driver backgate connects to the power pin and resumes charging, and the charge status output pin turns ON. Even when charging is stopped by this function, the  $t_{CHG}$  count is continued. When charging is completed, the charging status output pin maintains the OFF state even if the function activates due to disconnection of the input power or otherwise.

#### UVLO function

A UVLO function is incorporated. If the power input pin voltage,  $V_{IN}$  falls to 3.8V or lower during charging, this function turns off the output driver and stops charging. In addition, the charge status output pin changes to OFF. When the  $V_{IN}$  rises to 4V or higher, the IC starts up and charging begins. This function also detects voltage application to the power input pin.

#### Charge over-voltage monitoring function

To prevent charging of a battery in the over-voltage state, this function stops charging if the BAT pin voltage rises to 4.45V or higher and 50ms elapses.

At this time, the charge status output pin repeats ON-OFF at 1kHz on the XC6804A, and turns off on the XC6804B. When voltage is reapplied to the power input pin or the Li-ion battery is reconnected to the BAT pin, the IC starts up and charging begins.

#### Charge over-current monitoring function

To prevent charging of a battery by excessive current, this function stops charging if the charge current rises to 1200 mA or higher. At this time, the charge status output pin repeats ON-OFF at 1 kHz on the XC6804A, and turns off on the XC6804B. When voltage is reapplied to the power input pin or the Li-ion battery is reconnected to the BAT pin, the IC starts up and charging begins.

#### Recharge function

With the completion of charging, when the NTC thermistor temperature is  $0^{\circ}$ C or higher and less than 45°C, and the BAT pin voltage (V<sub>BAT</sub>) falls to 3.9 V or less, charging resumes. (charging is resumed 150ms after the charge start state is entered.)

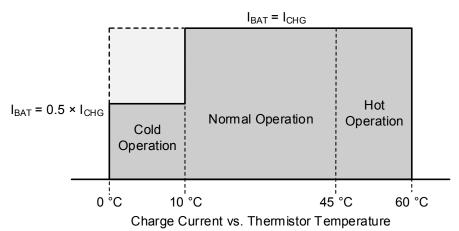
On the XC6804x4, if the NTC thermistor temperature is 45°C or higher and less than 60°C, charging automatically resumes when the

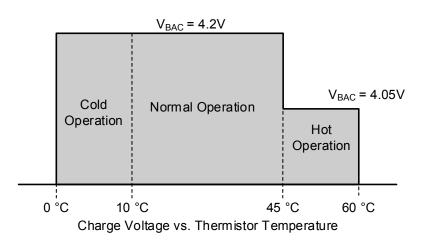
voltage falls to 3.75 V or less. This function is equiped only in the XC6804xxE, not in the XC6804xxD.

# ■ OPERATIONAL EXPLANATION (Continued)

#### Li-ion battery temperature monitoring function

The IC monitors the Li-ion battery temperature during charging by means of an NTC thermistor ("thermistor" below) connected to the THIN pin. The charge voltage  $V_{BAC}$  and the charge current  $I_{BAT}$  are controlled based on the Li-ion battery temperature as shown below to enable safe charging. The charge state changes 50 ms after the Li ion battery temperature reaches each of the change points.





#### • XC6804x4 (4 temperatures monitoring)

#### **Cold Operation**

When  $0^{\circ}$ C < NTC Temperature  $\leq 10^{\circ}$ C, the charge current is limited to  $I_{CHG} \times 0.5$ . (\*1)

When NTC Temperature ≤ 0°C, charging stops. (\*2)

#### **Normal Operation**

When 10°C < NTC Temperature < 45°C, charging takes place with the charge current I<sub>CHG</sub> and the charge voltage at 4.2 V. (\*1)

#### **Hot Operation**

When 45°C ≤ NTC Temperature < 60°C, the charge voltage changes to 4.05 V and charging continues. (\*1)

When 60°C ≤ Thermistor Temperature, charging stops. (\*2)

#### XC6804x3 (3 temperatures monitoring)

Comparing to the XC6804x4, the XC6804x3 does not monitor at 60°C and charging stops at 45°C ≤ Thermistor Temperature. (\*2)

#### • XC6804x2 (2 temperatures monitoring)

In contrast to the XC6804x4, the XC6804x2 does not have 10°C and 60°C monitoring, and stops charging when Thermistor Temperature  $\leq$  0°C and when Thermistor Temperature  $\geq$  45°C. (\*2)

In addition, when  $0^{\circ}$ C< Thermistor Temperature  $\leq 10^{\circ}$ C, the charge current does not change from  $I_{CHG}$ .

The thermistor temperature detection of this IC conforms to the characteristics of the NCP15XH103F03RC of Murata Manufacturing Co., Ltd.

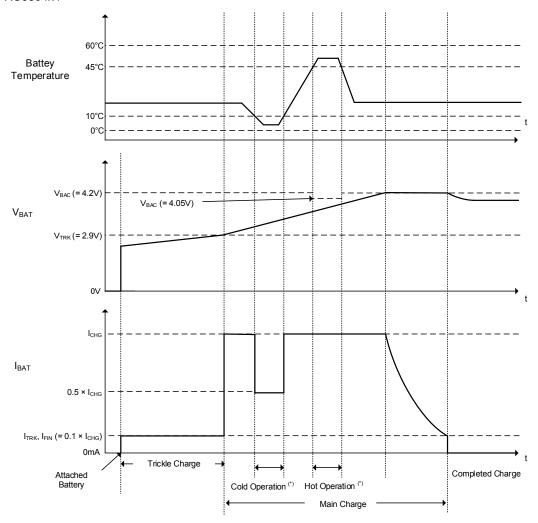
 $<sup>^{(*1)}</sup>$  During trickle charging, the charge current is limited to  $I_{CHG} \times 0.1$ .

<sup>(°2)</sup> Even when charging is stopped, t<sub>TRK</sub> count and t<sub>CHG</sub> count are continued and the charge status output pin maintains the ON state.

# ■ OPERATIONAL EXPLANATION (Continued)

Timing chart example

#### XC6804x4

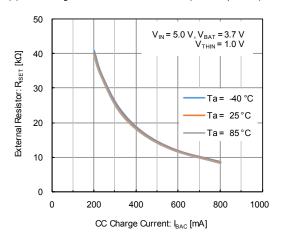


<sup>(\*)</sup> With regard to the detail of the Cold Operation and Hot Operation, please refer to "Li-ion battery temperature monitoring function" of the Operational Explanation on page 11.

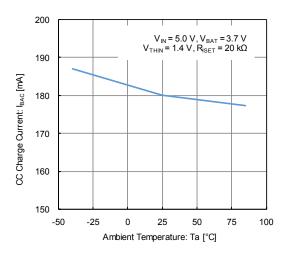
## ■NOTES ON USE

- 1. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
- 2. Where wiring impedance is high, operations may become unstable. Please strengthen  $V_{IN}$  and BAT wiring in particular.
- 3. Please wire the C<sub>IN</sub>, C<sub>L</sub> and charge current setting resistor to the IC as close as possible.
- 4. Do not connect anything other than a resistance for setting the charge current to the I<sub>SET</sub> pin.
- 5. Torex places an importance on improving our products and their reliability. We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.
- 6. This IC uses an external thermistor to detect and control temperature with high accuracy. Please sufficiently test the position of the external thermistor to ensure that it enables accurate temperature detection.
- 7. Reversing the polarity of the battery may cause destruction and is extremely dangerous. Never reverse the polarity of the battery.
- 8. Short-circuiting to neighboring pins may cause malfunctioning and destruction. Exercise sufficient caution when mounting and using the IC.
- 9. If a large ripple voltage occurs at the V<sub>IN</sub> pin, the IC may malfunction. Please test thoroughly.
- 10. Taking the temperature characteristics and the dispersion into consideration, please set the charge current not to exceed the range of 200mA to 800mA.
- 11. If the I<sub>SET</sub> pin is shorted to the GND, there is a possibility that the IC is destroyed before the over-current monitor function is activated.
- 12. When  $V_{BAT}$  is 1V or less, the error range of the trickle charge current becomes big. When  $V_{IN} V_{BAT}$  voltage is high in particular, please pay attention when using as there are possibilities that a large trickle current flows.
- 13. In case that the impedance between BAT pin and Li-ion battery is high at the CV charging under the low temperature, there are possibilities that V<sub>BAT</sub> oscillates and charge error takes place, so please place the Li-ion battery as close to the IC as possible.

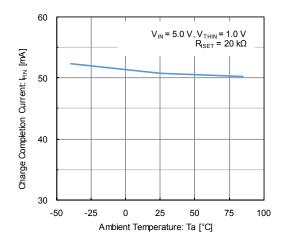
(1) CC Charge Current vs. External Resistor (Normal Operation)



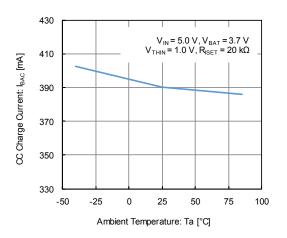
3) CC Charge Current vs. Ambient Temperature (Cold Operation)



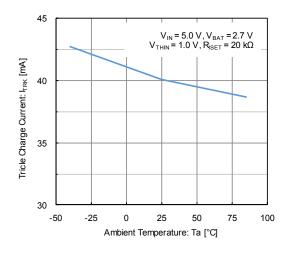
(5) Charge Completion Current vs. Ambient Temperature



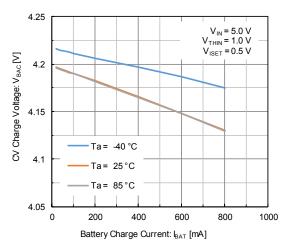
(2) CC Charge Current vs. Ambient Temperature (Normal Operation)



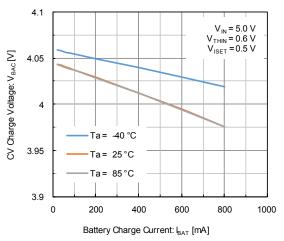
(4) Tricle Charge Current vs. Ambient Temperature



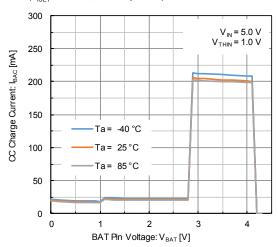
(6) CV Charge Voltage vs. Charge Current (Normal Operation)



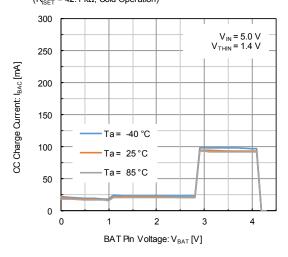
(7) CV Charge Voltage vs. Charge Current (Hot Operation)



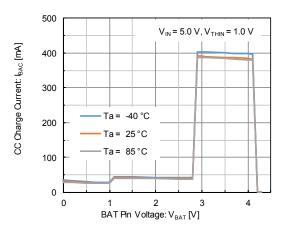
(8) CC Charge Current vs. BAT Pin Voltage  $(R_{ISET} = 42.1 \text{ k}\Omega, \text{ Normal Operation})$ 



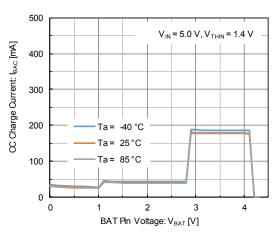
(9) CC Charge Current vs. BAT Pin Voltage  $(R_{ISET} = 42.1 \text{ k}\Omega, \text{ Cold Operation})$ 



(10) CC Charge Current vs. BAT Pin Voltage  $(R_{ISET} = 20 \; k\Omega, \; Normal \; Operation)$ 

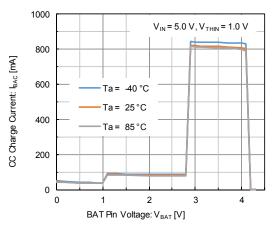


(11) CC Charge Current vs. BAT Pin Voltage  $(R_{ISET} = 20 \; k\Omega, \; Cold \; Operation)$ 

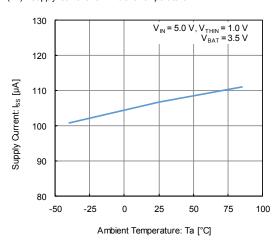


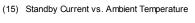
## TYPICAL PERFORMANCE CHARACTERISTICS

(12) CC Charge Current vs. BAT Pin Voltage  $(R_{ISET} = 8.6 \text{ k}Ω, Normal Operation})$ 



(14) Supply Current vs. Ambient Temperature





Ta = -40 °C

Ta = 25°C Га= 85°C

2

BAT Pin Voltage: V<sub>BAT</sub> [V]

(13) CC Charge Current vs. BAT Pin Voltage

 $V_{IN} = 5.0 \text{ V}, V_{THIN} = 1.4 \text{ V}$ 

3

 $(R_{ISET}$  = 8.6 kΩ, Cold Operation)

1000

800

600

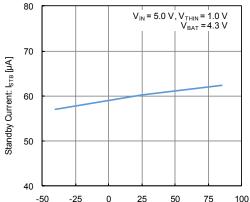
400

200

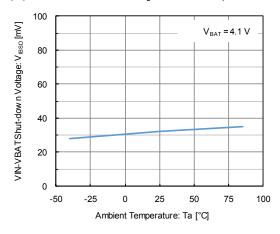
0

0

CC Charge Current: I<sub>BAC</sub> [mA]

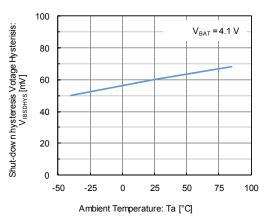


(16) VIN - VBAT Shut-down Voltage vs. Ambient Temperature

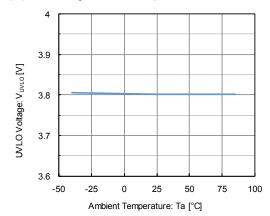


(17) Shut-down Hysteresis Voltage vs. Ambient Temperature

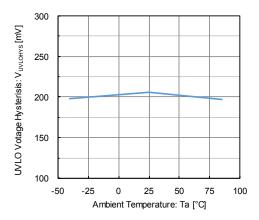
Ambient Temperature: Ta [°C]



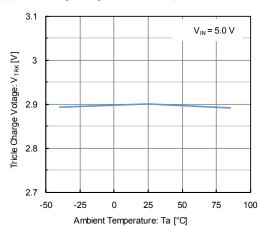
(18) UVLO Voltage vs. Ambient Temperature



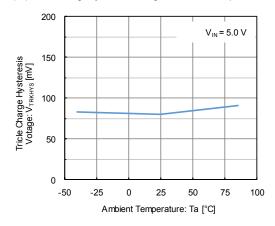
(19) UVLO Hysteresis Voltage vs. Ambient Temperature



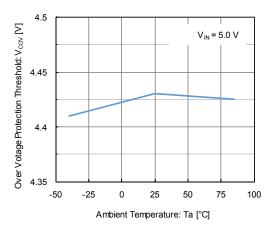
(20) Tricle Charge Voltage vs. Ambient Temperature



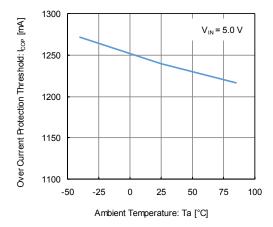
(21) Tricle Charge Hysteresis Voltage vs. Ambient Temperature



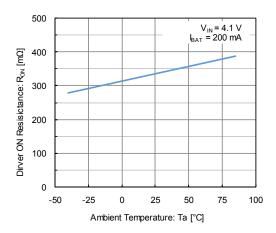
(22) Over Voltage Protection Threshold vs. Ambient Temperature



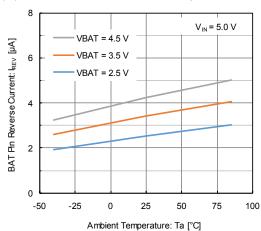
(23) Over Current Protection Threshold vs. Ambient Temperature



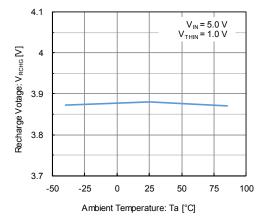
(24) Driver ON Resistance vs. Ambient Temperature



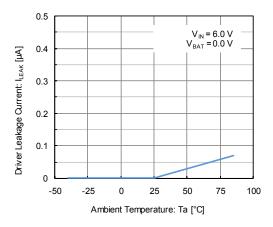
(26) BAT Pin Reverse Cuurent vs. Ambient Temperature



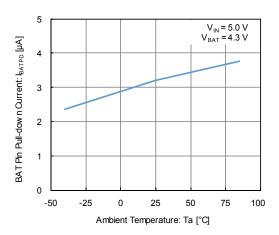
(28) Recharge Voltage vs. Ambient Temperature (Normal Operation)



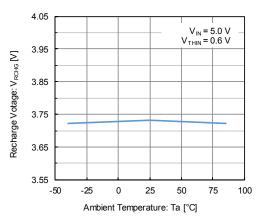
(25) Driver Leakage Current vs. Ambient Temperature



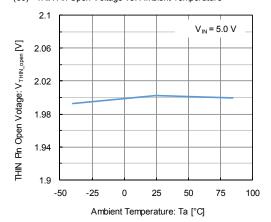
(27) BAT Pin Pull-down Current vs. Ambient Temperature



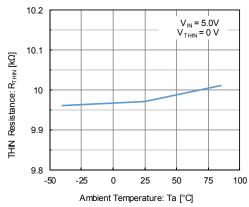
(29) Recharge Voltage vs. Ambient Temperature (Hot Operation)



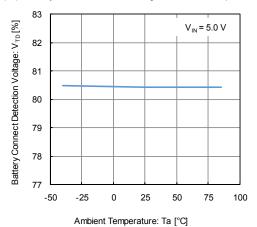
(30) THIN Pin Open Voltage vs. Ambient Temperature



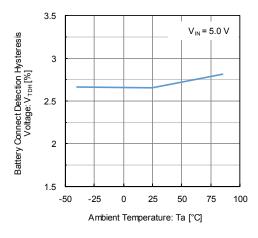
(31) THIN Pin Connected Resistance vs. Ambient Temperature



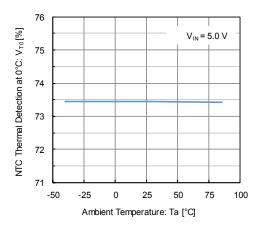
(32) Battery Connect Detection Voltage vs. Ambient Temperature



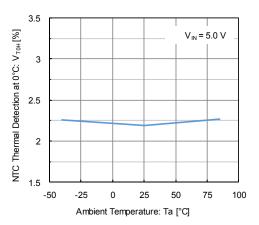
(33) Battery Connect Detection Hysteresis Voltage vs. Ambient Temperature



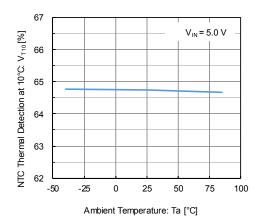
(34) Thermistor Detection at 0°C vs. Ambient Temperature



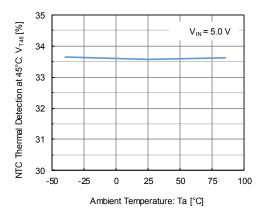
(35) Thermistor Detection Hysteresis at 0°C vs. Ambient Temperature



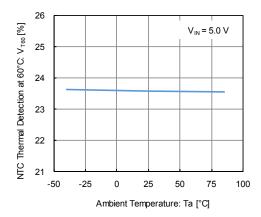
(36) Thermistor Detection at 10°C vs. Ambient Temperature



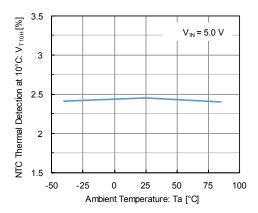
(38) Thermistor Detection at 45°C vs. Ambient Temperature



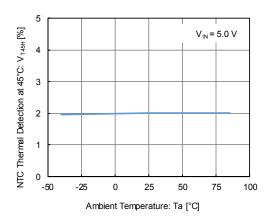
(40) Thermistor Detection at 60°C vs. Ambient Temperature



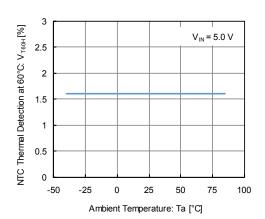
(37) Thermistor Detection Hysteresis at 10°C vs. Ambient Temperature



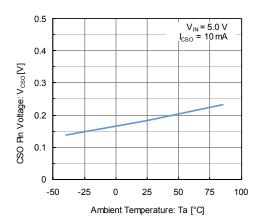
(39) Thermistor Detection Hysteresis at 45  $^{\circ}\text{C}\,\text{vs.}$  Ambient Temperature



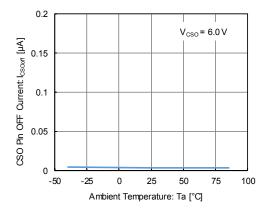
(41) Thermistor Detection Hysteresis at 60°C vs. Ambient Temperature



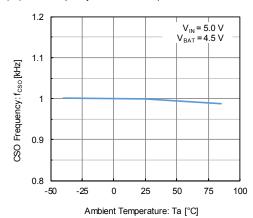
### (42) CSO Pin ON Voltage vs. Ambient Temperature



### (43) CSO Pin OFF Current vs. Ambient Temperature

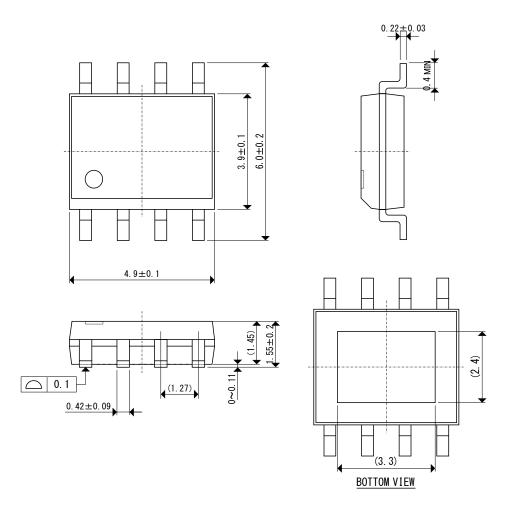


#### (44) CSO Frequency vs. Ambient Temperature

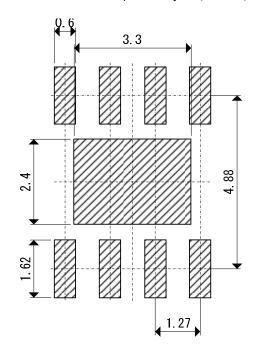


# **■**PACKAGING INFORMATION

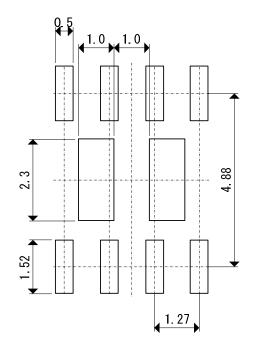
●SOP-8FD (unit: mm)



●SOP-8FD Reference pattern layout (unit: mm)

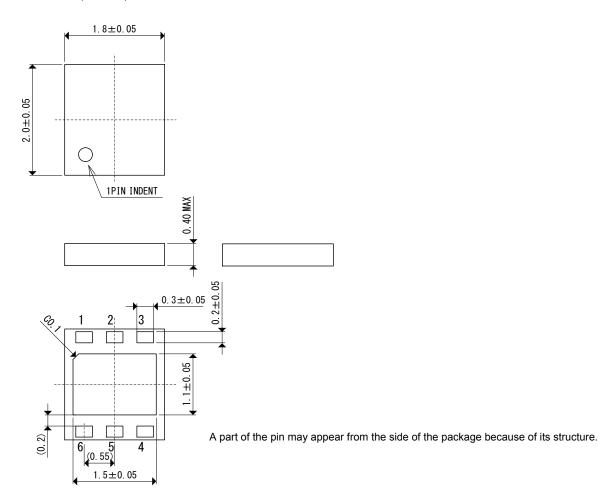


●SOP-8FD Reference metal mask design (unit: mm)

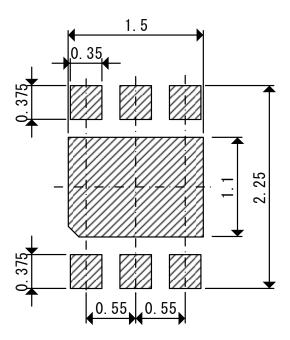


# ■ PACKAGING INFORMATION (Continued)

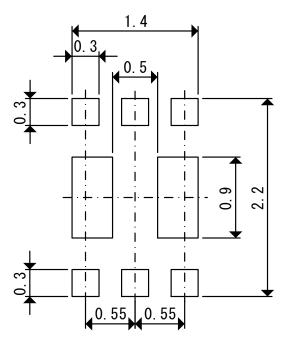
#### USP-6EL (unit: mm)



USP-6EL Reference pattern layout (unit: mm)



• USP-6EL Reference metal mask design (unit: mm)



#### SOP-8FD Power Dissipation

Power dissipation data for the SOP-8FD is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

#### 1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

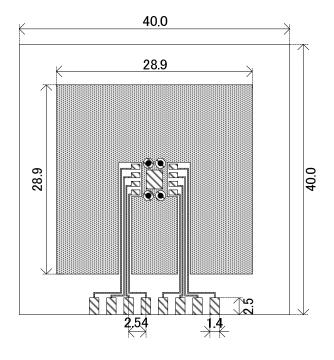
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

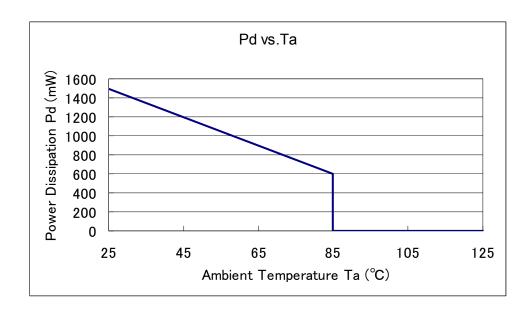
Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter



# 2. Power Dissipation vs. Ambient temperature Board Mount (Tj max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C /W)
25	1500	66.67
85	600	00.07



#### ●USP-6EL Power Dissipation

Power dissipation data for the USP-6EL is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

#### 1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm<sup>2</sup> in one side)

Copper (Cu) traces occupy 50% of the board area

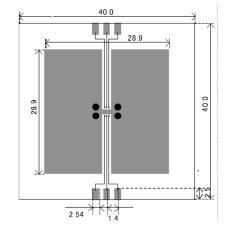
in top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

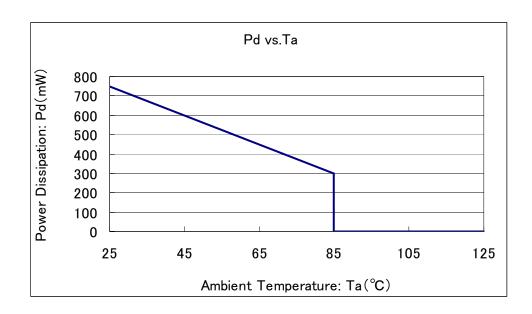
Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

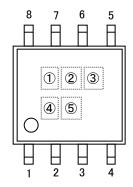
# 2. Power Dissipation vs. Ambient temperature Board Mount (Tj max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C /W)
25	750	122.22
85	300	133.33

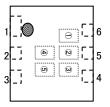


# ■ MARKING RULE

### ●SOP-8FD



# ●USP-6EL



## ① represents product series

MARK	PRODUCT SERIES
4	XC6804*****-G

### 2 represents charge status output on abnormal mode

MARK	PRODUCT SERIES
0	XC6804A****-G
1	XC6804B****-G

③ represents battery temperature monitor function and recharge function

	, ,		,
MARK	CHARGE STATUS OUTPUT ON ABNORMAL MODE	BATTERY TEMPERATURE MONITOR FUNCTION	PRODUCT SERIES
Н	2 Temperature Monitor	Enable	XC6804*2E**-G
F	2 Temperature Monitor	Disable	XC6804*2D**-G
Е	3 Temperature Monitor	Enable	XC6804*3E**-G
D	3 Temperature Monitor	Disable	XC6804*3D**-G
С	4 Temperature Monitor	Enable	XC6804*4E**-G
В	4 Temperature Monitor	Disable	XC6804*4D**-G

④,⑤ represents production lot number 01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to AZ, B1 to ZZ repeated (G, I, J, O, Q, W excluded)

<sup>\*</sup>No character inversion used.

- 1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
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- 5. Although we make continuous efforts to improve the quality and reliability of our products; nevertheless Semiconductors are likely to fail with a certain probability. So in order to prevent personal injury and/or property damage resulting from such failure, customers are required to incorporate adequate safety measures in their designs, such as system fail safes, redundancy and fire prevention features.
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- 7. Please use the product listed in this datasheet within the specified ranges.
- 8. We assume no responsibility for damage or loss due to abnormal use.
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